

**ADVANCED
POWER
TECHNOLOGY®**

APT6040BNR 600V 18.0A 0.40Ω

APT6045BNR 600V 17.0A 0.45Ω

POWER MOS IV®

UIS RATED

N-CHANNEL ENHANCEMENT MODE HIGH VOLTAGE POWER MOSFETS

MAXIMUM RATINGS

All Ratings: $T_C = 25^\circ\text{C}$ unless otherwise specified.

Symbol	Parameter	APT6040BNR	APT6045BNR	UNIT
V_{DSS}	Drain-Source Voltage	600	600	Volts
I_D	Continuous Drain Current @ $T_C = 25^\circ\text{C}$	18	17	Amps
I_{DM}	Pulsed Drain Current ①	72	68	
V_{GS}	Gate-Source Voltage Continuous	±20		Volts
V_{GSM}	Gate-Source Voltage Transient	±30		
P_D	Total Power Dissipation @ $T_C = 25^\circ\text{C}$	310		Watts
	Linear Derating Factor	2.5		W/°C
T_J, T_{STG}	Operating and Storage Junction Temperature Range	-55 to 150		°C
T_L	Lead Temperature: 0.063" from Case for 10 Sec.	300		
I_{AR}	Avalanche Current ① (Repetitive and Non-Repetitive)	18		Amps
E_{AR}	Repetitive Avalanche Energy ①	25		mJ
E_{AS}	Single Pulse Avalanche Energy ④	1210		

STATIC ELECTRICAL CHARACTERISTICS

Symbol	Characteristic / Test Conditions	MIN	TYP	MAX	UNIT
BV_{DSS}	Drain-Source Breakdown Voltage ($V_{GS} = 0\text{V}$, $I_D = 250\ \mu\text{A}$)	600			Volts
$I_D(\text{ON})$	On State Drain Current ②	APT6040BNR	18		Amps
	($V_{DS} > I_D(\text{ON}) \times R_{DS}(\text{ON})$ Max, $V_{GS} = 10\text{V}$)	APT6045BNR	17		
$R_{DS}(\text{ON})$	Drain-Source On-State Resistance ②	APT6040BNR		0.40	Ohms
	($V_{GS} = 10\text{V}$, $0.5 I_D$ [Cont.])	APT6045BNR		0.45	
I_{DS}	Zero Gate Voltage Drain Current ($V_{DS} = V_{DSS}$, $V_{GS} = 0\text{V}$)			250	μA
	Zero Gate Voltage Drain Current ($V_{DS} = 0.8 V_{DSS}$, $V_{GS} = 0\text{V}$, $T_C = 125^\circ\text{C}$)			1000	
I_{GS}	Gate-Source Leakage Current ($V_{GS} = \pm 20\text{V}$, $V_{DS} = 0\text{V}$)			±100	nA
$V_{GS(\text{TH})}$	Gate Threshold Voltage ($V_{DS} = V_{GS}$, $I_D = 1.0\text{mA}$)	2		4	Volts

THERMAL CHARACTERISTICS

Symbol	Characteristic	MIN	TYP	MAX	UNIT
$R_{θJC}$	Junction to Case			0.40	°C/W
$R_{θJA}$	Junction to Ambient			40	

CAUTION: These Devices are Sensitive to Electrostatic Discharge. Proper Handling Procedures Should Be Followed.

405 S.W. COLUMBIA STREET
BEND, OREGON 97702-1035
U.S.A.

PHONE . . . (503) 382-8028

FAX (503) 388-0364

DYNAMIC CHARACTERISTICS

APT6040/6045BNR

Symbol	Characteristic	Test Conditions	MIN	TYP	MAX	UNIT
C_{iss}	Input Capacitance	$V_{GS} \approx 0V$ $V_{DS} = 25V$ $f = 1 MHz$		3000		pF
C_{oss}	Output Capacitance			445		
C_{rss}	Reverse Transfer Capacitance			166		
Q_g	Total Gate Charge ①	$V_{GS} = 10V$ $V_{DD} = 0.5 V_{DSS}$ $I_D = I_D [Cont.] @ 25^\circ C$		113		nC
Q_{gs}	Gate-Source Charge			12		
Q_{gd}	Gate-Drain ("Miller") Charge			64		
$t_d(on)$	Turn-on Delay Time	$V_{GS} = 15V$ $V_{DD} = 0.5 V_{DSS}$ $I_D = I_D [Cont.] @ 25^\circ C$ $R_G = 1.8\Omega$		16		ns
t_r	Rise Time			23		
$t_d(off)$	Turn-off Delay Time			88		
t_f	Fall Time			26		

SOURCE-DRAIN DIODE RATINGS AND CHARACTERISTICS

Symbol	Characteristic / Test Conditions	MIN	TYP	MAX	UNIT
I_S	Continuous Source Current (Body Diode)	APT6040BNR		18	Amps
				17	
I_{SM}	Pulsed Source Current ① (Body Diode)	APT6040BNR		72	
				68	
V_{SD}	Diode Forward Voltage ② ($V_{GS} = 0V$, $I_S = -I_D [Cont.]$)			1.3	Volts
t_{rr}	Reverse Recovery Time ($I_S = -I_D [Cont.]$, $dI_S/dt = 100A/\mu s$)	152	334	668	ns
Q_{rr}	Reverse Recovery Charge ($I_S = -I_D [Cont.]$, $dI_S/dt = 100A/\mu s$)	2.5	5	10	μC

SAFE OPERATING AREA CHARACTERISTICS

Symbol	Characteristic	Test Conditions	MIN	TYP	MAX	UNIT
SOA1	Safe Operating Area	$V_{DS} = 0.4 V_{DSS}$, $I_{DS} = P_D / 0.4 V_{DSS}$, $t = 1 Sec.$	310			Watts
SOA2	Safe Operating Area		310			
I_{LM}	Inductive Current Clamped	APT6040BNR	72			Amps
			68			

① Repetitive Rating: Pulse width limited by maximum junction temperature.

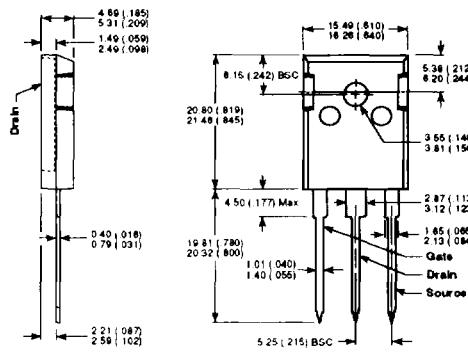
③ See MIL-STD-750 Method 3471

④ Starting $T_J = +25^\circ C$, $L = 7.47mH$, $R_G = 25\Omega$, Peak $I_L = 18A$

② Pulse Test: Pulse width < 380 μs , Duty Cycle < 2%

APT Reserves the right to change, without notice, the specifications and information contained herein.

TO-247AD Package Outline



Dimensions in Millimeters and (Inches)